



High Power Shielded Low Profile Surface Mount Inductors

- Operating Temperature Range -40°C to +180°C
- Temperature Rise, Maximum 50°C

Specifications

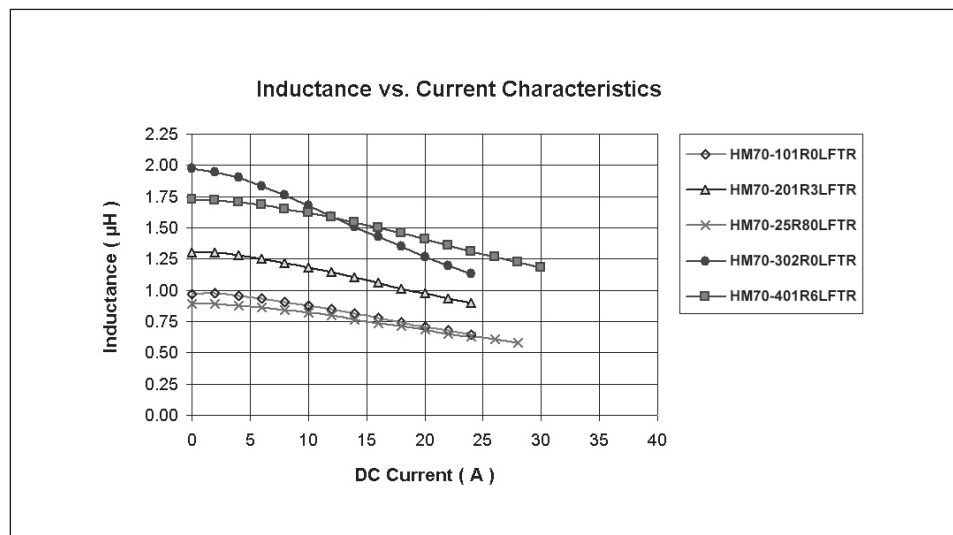
Part Number	Inductance 100kHz, 0.1V			DCR ⁽¹⁾ (mΩ)		I _{sat} ⁽²⁾ @ 25°C (A _{dc})	Heating ⁽³⁾ Current (A _{dc}) ΔT=50°C	Core Loss ⁽⁴⁾ Factor		Fig.
	@ 0 A _{dc} (μH ± 20%)	@ I _{sat} (μH)		Typ.	Max.			K1	K2	
	Typ.	Min.	Typ.							
HM70-101R0LF	1.00	0.63	0.70	2.53	2.90	16	15	9.07E-11	170.67	1
HM70-201R3LF	1.33	0.93	1.16	3.38	3.74	16	13	1.24E-10	157.15	1
HM70-201R9LF	1.94	1.28	1.60	4.71	5.42	12	11	1.24E-10	189.83	1
HM70-25R80LF	0.83	0.488	0.61	1.75	2.01	18	19	1.51E-10	118.84	1
HM70-301R5LF	1.50	0.80	1.00	2.16	2.48	16	17	1.40E-10	183.07	1
HM70-302R0LF	2.10	1.12	1.40	3.48	4.00	12	14	1.53E-10	196.09	1
HM70-321R3LF	1.30	0.80	1.00	2.16	2.48	16	17	1.66E-10	140.35	1
HM70-351R5LF	1.50	0.97	1.20	4.00	4.50	18	13	1.35E-10	166.20	2
HM70-401R2LF	1.20	0.92	1.02	1.75	1.80	18	22	1.80E-10	129.45	2
HM70-401R6LF	1.60	1.15	1.44	2.13	2.36	20	20	1.67E-10	151.67	2
HM70-50R70LF	0.70	0.40	0.52	1.05	1.26	30	31	1.99E-10	88.15	2
HM70-501R2LF	1.20	0.80	0.90	1.68	2.00	24	25	1.99E-10	110.82	2
HM70-505R0LF	5.00	3.60	4.30	6.50	8.00	7	13	2.21E-10	219.63	2
HM70-50100LF	10.0	6.80	8.00	12.0	15.0	7	9	2.21E-10	316.67	2
HM70-601R2LF	1.20	0.80	1.00	1.37	1.58	20	28	2.21E-10	108.94	2
HM70-602R0LF	2.00	1.20	1.60	2.20	2.60	15	22	2.21E-10	143.34	2

- Notes:
- (1) DC resistance is measured at 25°C
 - (2) The saturation current (I_{sat}) is the current at which the inductance will be decreased by 20% from its initial (zero DC) value.
 - (3) The heating current is the DC current, which causes the component temperature to increase by approximately 50°C. This current is determined by soldering the component on a typical application PCB, and then apply the current to the device for 30 minutes.
 - (4) Core Loss approximation is based on published core data:

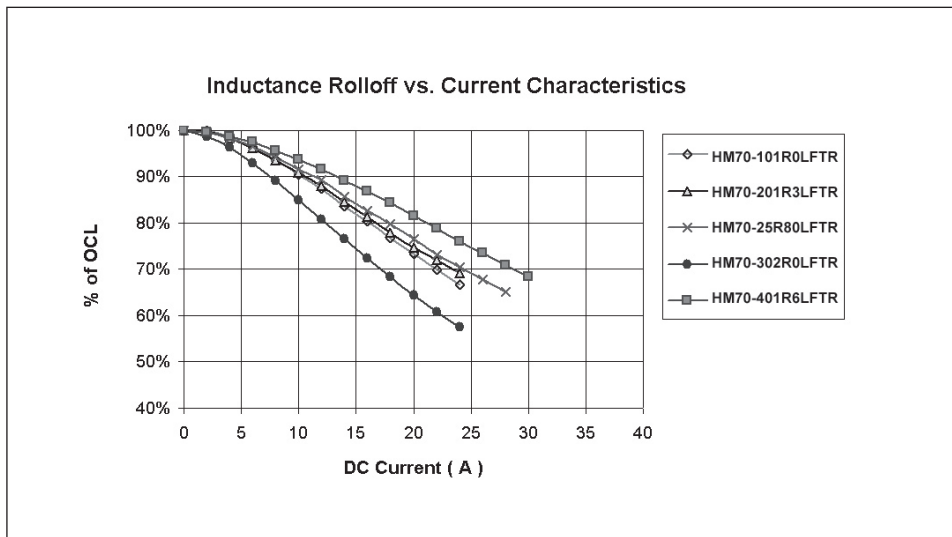
$$\text{Core Loss (Pfe)} = K1 * (f)^{1.358} * (K2\Delta I)^{2.2546}$$
 Where: core loss in watt
 K1 and K2 = core loss factor
 K2ΔI = one half of the peak to peak flux density across the component in Gauss
 f = frequency in kHz
 ΔI = delta I across the component in Amp.

Electrical Characteristics @ 25°C

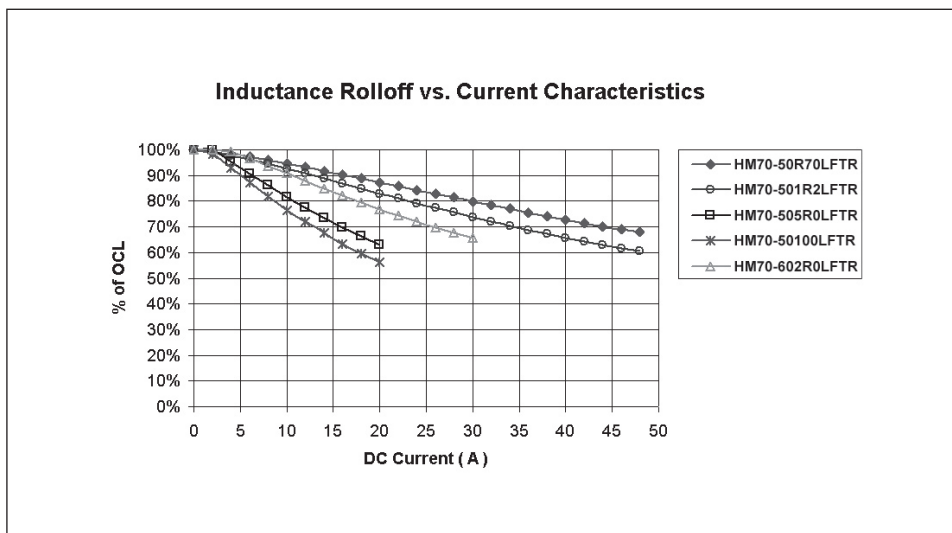
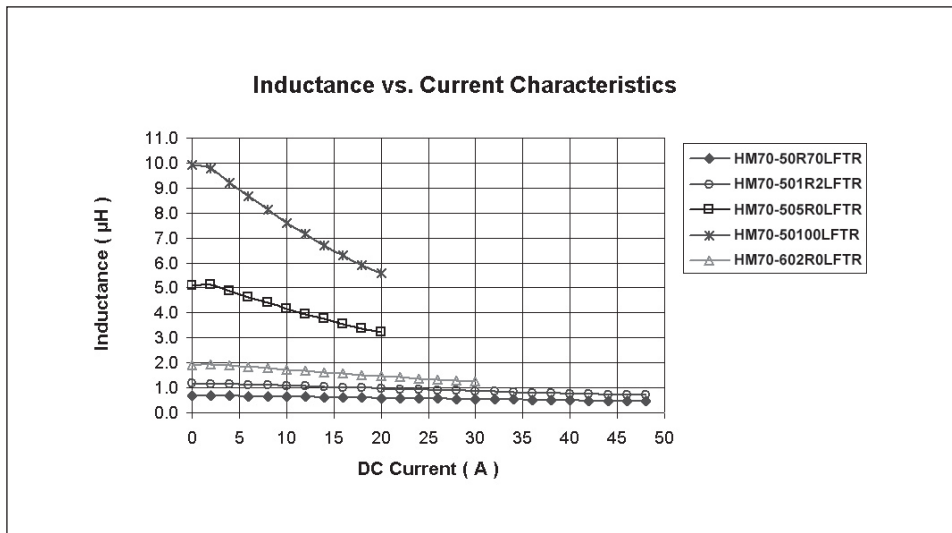
(A) Case size 10, 20, 25, 30 & 40



Electrical Characteristics @ 25 °C (Cont'd)



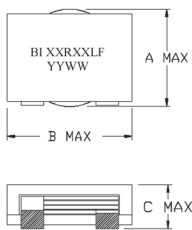
(B) Case size 50 & 60



Outline Dimensions (mm)

Figure 1

Top View



Bottom View

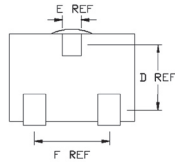
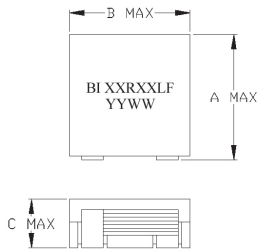
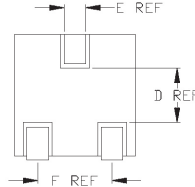


Figure 2

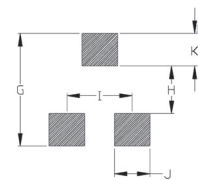
Top View



Bottom View



Recommended Solder Pad Layout



Case size	A	B	C	D	E	F	G	H	I	J	K
10	9.00	10.5	3.70	4.80	1.70	6.00	8.30	2.30	6.00	2.80	3.00
20	9.00	10.5	4.50	4.80	1.70	6.00	8.00	2.00	6.00	2.80	3.00
25	9.00	10.5	5.00	4.80	1.70	6.00	8.30	2.30	6.00	2.80	3.00
30	9.00	10.5	5.20	4.80	1.70	6.00	8.00	2.00	6.00	2.80	3.00
32	9.00	10.5	5.60	4.80	1.70	6.00	8.00	2.00	6.00	2.80	3.00
35	10.7	10.25	4.20	5.60	1.70	6.00	10.6	5.60	6.20	2.10	2.50
40	11.0	12.6	5.20	6.20	2.30	7.50	10.7	3.70	7.50	3.10	3.50
50	13.5	12.9	5.50	6.50	2.30	7.50	13.5	6.50	7.50	3.00	3.50
60	14.0	13.0	5.80	6.50	2.30	7.50	14.0	6.50	7.50	3.00	3.50

Packaging

Standard: Embossed Tape & Reel

Reel:	Diameter:	=	13" (330.2mm)
Capacity:	Case size 10,20,25,30,32	=	500 Units
	Case size 35,40,50,60	=	400 Units

Ordering Information



Inductance Code: First 2 digits are significant. Last digit denotes the number of trailing zeros. For values below 10 μ H, "R" denotes the decimal point.